

AMENDMENTS TO THE SPECIFICATION

Please replace paragraph [0002] of Applicant's application, as previously presented, with the following amended paragraph:

[0002] The following ~~co-pending and~~ commonly-assigned U.S. Patents and U.S. Patent Applications, filed on even date herewith, are also incorporated herein by reference in their entirety:

1. U.S. Patent No. 7,212,864 ~~Application Serial No. 10/731,869~~, entitled "MODULAR IMPLANTABLE MEDICAL DEVICE," to Carl D. Wahlstrand et al., and filed December 9, 2003 and issued on May 1, 2007;
2. U.S. Patent Application Publication No. 2004/0173221 ~~Serial No. 10/731,868~~, entitled "IMPLANTATION OF LOW-PROFILE IMPLANTABLE MEDICAL DEVICE," to Ruchika Singhal et al., and filed December 9, 2003;
3. U.S. Patent Application Publication No. 2004/0172090 ~~Serial No. 10/731,699~~, entitled "COUPLING MODULE OF A MODULAR IMPLANTABLE MEDICAL DEVICE," to Darren A. Janzig et al., and filed December 9, 2003;
4. U.S. Patent No. 7,242,982 ~~Application Serial No. 10/730,873~~, entitled "OVERMOLD FOR A MODULAR IMPLANTABLE MEDICAL DEVICE," to Ruchika Singhal et al., and filed December 9, 2003 and issued on July 10, 2007;
5. U.S. Patent No. 7,392,089 ~~Application Serial No. 10/731,881~~, entitled "REDUCING RELATIVE INTER-MODULE MOTION IN A MODULAR IMPLANTABLE MEDICAL DEVICE," to Carl D. Wahlstrand et al., and filed December 9, 2003 and issued on June 24, 2008;
6. U.S. Patent Application Publication No. 2004/0176815 ~~Serial No. 10/730,877~~, entitled "LOW-PROFILE IMPLANTABLE MEDICAL DEVICE," to Darren A. Janzig et al., and filed December 9, 2003;
7. U.S. Patent No. 7,529,586 ~~Application Serial No. 10/731,867~~, entitled "CONCAVITY OF AN IMPLANTABLE MEDICAL DEVICE," to Carl D. Wahlstrand et al., and filed December 9, 2003 and issued on May 5, 2009; and

8. U.S. Patent ~~No. 7,212,864~~ ~~Application Serial No. 10/731,638~~, entitled "MODULAR IMPLANTABLE MEDICAL DEVICE," to Carl D. Wahlstrand et al., and filed December 9, 2003 and issued on May 1, 2007.

Please replace paragraph [0044] of Applicant's originally-filed disclosure with the following amended paragraph:

[0044] Additional details regarding the set of motion restriction devices 521 are described in ~~co-~~~~pending and~~ commonly assigned U.S. Patent ~~Application No. 7,392,089~~, entitled "REDUCING RELATIVE INTER-MODULE MOTION IN A DISTRIBUTED MODULAR IMPLANTABLE MEDICAL DEVICE," which issued on June 24, 2008 ~~assigned Attorney Docket No.: 1023-333US01/P-11797.00.~~

Please replace paragraph [0050] of Applicant's originally-filed disclosure with the following amended paragraph:

[0050] Additional details regarding the overmold 522 are described in ~~co-~~~~pending and~~ commonly assigned U.S. Patent ~~No. 7,242,982~~ ~~Application~~, entitled "OVERMOLD FOR A MODULAR IMPLANTABLE MEDICAL DEVICE," which issued on July 10, 2007 ~~assigned Attorney-~~~~Docket No.: 1023-332US01/P-11798.00.~~